SMC 2008 Student Activities

The Student Activities Committee hosted a series of student activities and conducted a membership drive for new members at the 2008 International Conference on Systems, Man and Cybernetics, recently held in Singapore during October 12-15, 2008.

SMC Membership Booth

The SMC Membership Booth included photos of Society officers and a description of membership categories and benefits. Hundreds of international conference delegates from China, Taiwan, Japan, U.S. and Canada were introduced to the benefits of joining IEEE and the SMC Society in technical, networking and career aspects. Those attendees who joined on-site were given an elegant souvenir.



Best Student Paper Award

Five finalists were selected from more than 350 qualified papers in the Best Student Paper Award. The Judging Committee was chaired by Professor Chong Jin Ong with Professor William A. Gruver, Professor Tong Heng Lee, Professor Witold Pedrycz and Dr. Michael Smith. A special award session was held on the first day of the Conference. Each finalist was awarded a certificate of merit.









G.O.L.D. Reception

Student Activities Chair, Patrick Chan gave a presentation to introduce how IEEE and the SMC Society benefit students. To recognize a contribution to SMC Society Student Branch Chapters, a Certificate of Appreciation signed by SMC President, Professor Daniel Yeung and SMC Vice President Membership and Student Activities, Professor T. T. Lee was presented by SMC President. The high level of interest from delegates is expected to result in increased membership to the SMC Society, particularly in Region 10.











Student Volunteer and Student Travel Grant

During 2008, the SMC Society supported nine Student Volunteers (selected from more than 55 applicants). These volunteers had the opportunity to be involved in the conference activities and gained valuable experience. Moreover, the registration fee for the student volunteers was waived. Nine students selected from more than 35 applicants received a Student Travel Grant to attend the Conference. Each grant provided a maximum amount of \$500 USD.